

3A, 400V ESD Capability Rectifier

FEATURES

- AEC-Q101 qualified
- High ESD capability
- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	3	A
V_{RRM}	400	V
I_{FSM}	100	A
$T_{J\ MAX}$	175	°C
Package	DO-214AB (SMC)	
Configuration	Single die	

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- General purpose



MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)



DO-214AB (SMC)



SOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	TSD3GH	UNIT
Marking code on the device		TSD3G	
Repetitive peak reverse voltage	V_{RRM}	400	V
Reverse voltage, total rms value	$V_{R(RMS)}$	280	V
Forward current	I_F	3	A
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	100	A
Junction temperature	T_J	- 55 to +175	°C
Storage temperature	T_{STG}	- 55 to +175	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	21	$^{\circ}C/W$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	59	$^{\circ}C/W$
Junction-to-case thermal resistance	$R_{\theta JC}$	22	$^{\circ}C/W$

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1.5A, T_J = 25^{\circ}C$	V_F	0.85	0.95	V
	$I_F = 3.0A, T_J = 25^{\circ}C$		0.89	1.00	V
	$I_F = 1.5A, T_J = 125^{\circ}C$		0.72	0.90	V
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.76	1.00	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^{\circ}C$	I_R	-	1	μA
	$T_J = 125^{\circ}C$		-	50	μA
Junction capacitance	1MHz, $V_R = 4.0V$	C_J	45	-	pF

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25^{\circ}C$ unless otherwise noted)						
Standard	Test Type	Test Conditions	Symbol	Class	Value	Typical
AEC-Q101-001	Human body model(contact mode)	$C=100pF, R=1.5k\Omega$	V_c	H3B	$\geq 8kV$	N/A
IEC 61000-4-2	Contact mode	$C=150pF, R=330\Omega$		4	$\geq 8kV$	25kV
	Air-discharge mode	$C=150pF, R=330\Omega$		4	$\geq 15kV$	30kV
ISO 10605	Contact mode	$C=330pF, R=330\Omega$		L4	$\geq 15kV$	25kV
	Air-discharge mode	$C=330pF, R=330\Omega$		L4	$\geq 25kV$	30kV

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TSD3GH	DO-214AB (SMC)	3,000 / Tape & Reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

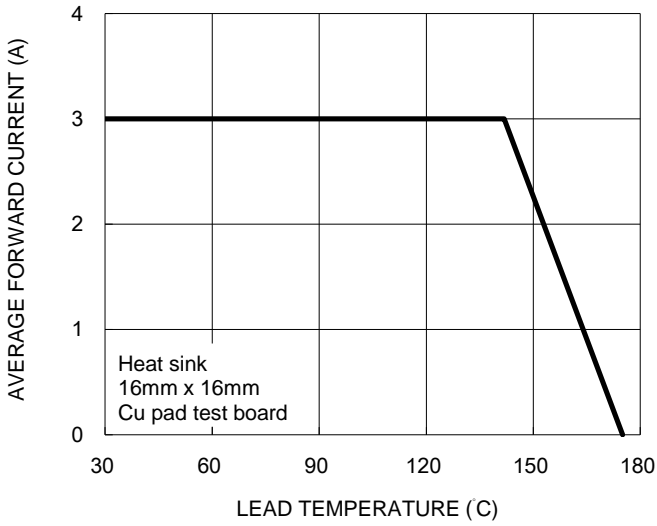


Fig.2 Typical Junction Capacitance

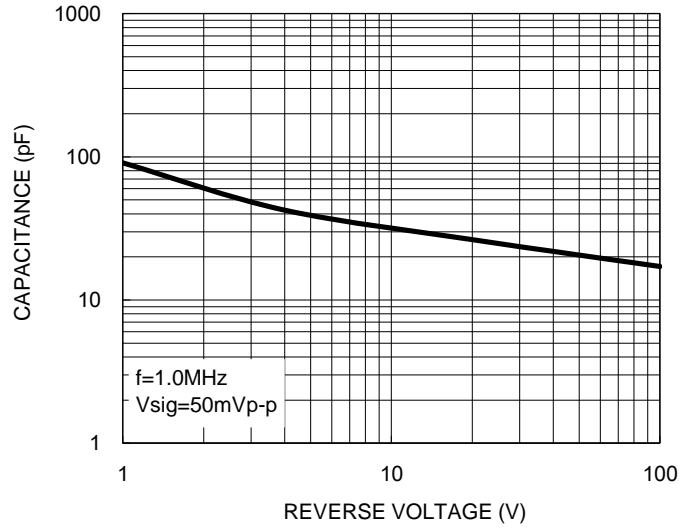


Fig.3 Typical Reverse Characteristics

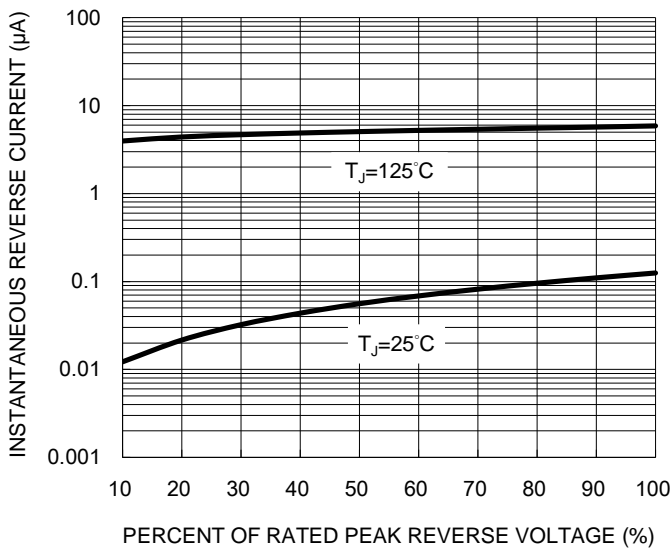
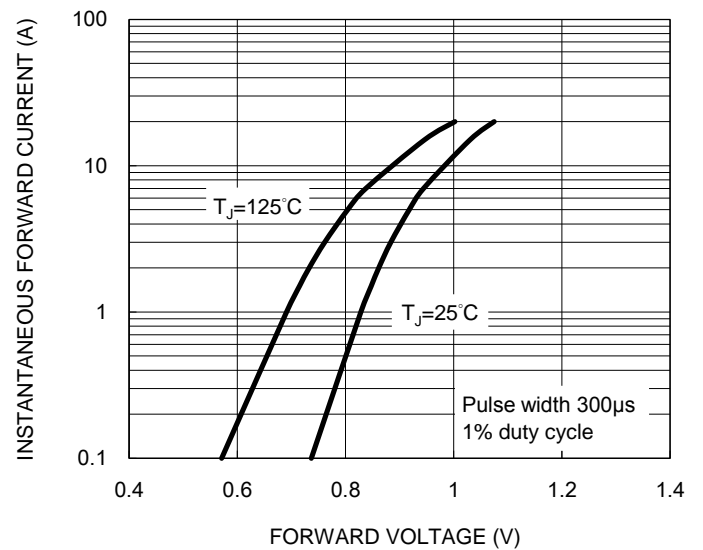
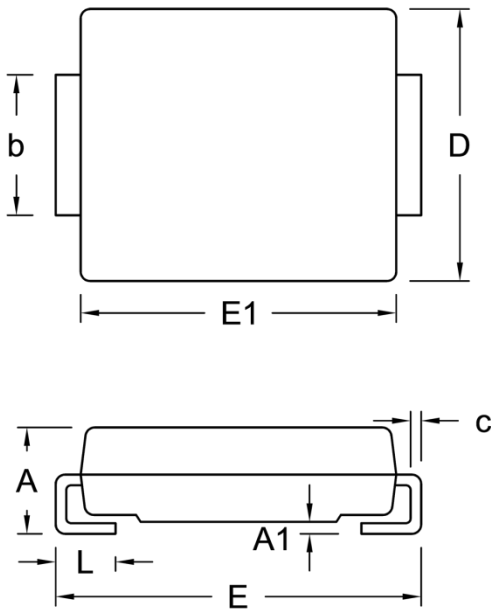


Fig.4 Typical Forward Characteristics



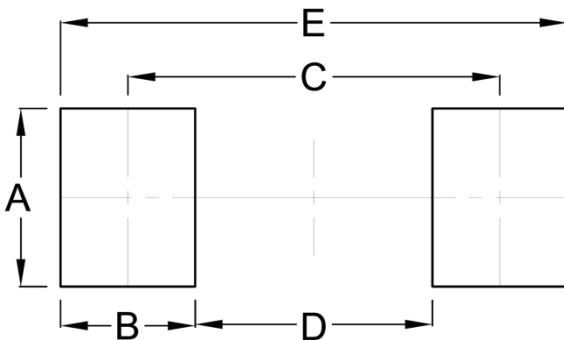
PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.90	0.272
D	4.40	0.173
E	9.40	0.370

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code

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